



This is to certify that the Electrostatic Discharge Control Program for:

Micross Silicon Turnkey Solutions Hi-Reliability Microelectronics

1804 McCarthy Blvd
Milpitas, CA 95035
United States of America

applicable to:

Contract / Purchase Order Review, Component and System Level Reliability & Qualification through Environmental / Reliability & Burn In Testing (Nondestructive Testing (Ultrasonic Testing), Non-Metallic Materials Testing (Thermal Testing), and Materials Testing Lab (Specimen Response /Capability to Heat Treat) and Value-added Screening, Specialty Assembly & Packaging for Commercial, Industrial, Aerospace & Military Microelectronics at Silicon Turnkey Solutions, Inc. and Hi-Reliability Microelectronics (To include Xray)

has been assessed and registered by National Quality Assurance, USA against the provisions of:

ANSI/ESD S20.20-2021

A handwritten signature in black ink, likely belonging to Charles Morton, the USA Manager.

For and on behalf of NQA, USA.



Certificate Number: ESD23007

First Issued: May 21, 2024

Valid Until: May 20, 2027

Reissued: June 5, 2026

Lead Auditor Michael Thorney

Approving NQA, USA Manager: Charles Morton

Client ESD Program Manager: David Nguyen